









	SW-C]	MM Levels
Level	Focus	Decription
5: Optimizing	Continuous Process Improvement	Continuous process improvement is enabled by quantitative feedback from the process and from piloting innovative ideas and technologies.
4: Managed	Product and Process Quality	Detailed measures of the software process and product quality are collected. Both the software process and products are quantitatively understood and controlled.
3: Defined	Engineering Process	The software process for both management and engineering activities is documented, standardized, and integrated into a standard software process for the organization. All projects use an approved, tailored version of the organization's standard software process for developing and maintaining software.
2: Repeatable	Project Management	Basic project management processes are established to track cost, schedule, and functionality. The necessary process discipline is in place to repeat earlier successes on projects with similar applications.
	No Focus	Project success primary depends on individuals







PSP	Key Pr	ocess Areas
Level	Focus	Key Process Area
5: Optimizing	Continuous Process Improvement	Defect Prevention (PSP)     Technology Change Management (PSP)     Process Change Management (PSP)
4: Managed	Product and Process Quality	Quantitative Process Management (PSP)     Software Quality Management (PSP)
3: Defined	Engineering Process	Organizational Process Focus (PSP)     Organizational Process Definition (PSP)     Integrated Software Management (PSP)     Training Program     Software Product Engineering (PSP)     Intergroup Coordination     Peer Reviews (PSP)
2: Repeatable	Project Management	Requirements Management     Software Project Planning (PSP)     Software Project Tracking and Oversight (PSP     Software Subcontract Management     Software Quality Assurance     Software Configuration Management































P	lan Sum	mar	y Fo	rm		
<br - ?	Program Size (LOC)	Plan	Actual	To Date		Т
🧢	Total New & Changed					1
<ul> <li>Measured data is</li> </ul>	Maximum Size					4
used for planning	Time in Phase (min.)	Plan	Actual	To Date	To Date %	1
totaling,	Planning					4
tracking and	Design Design Review					4
analyzing software	Code					1
development	Code Review					4
	Test					
activities.	Postmortem					1
<ul> <li>The Plan Summary</li> </ul>	A Naximum Time					+
	Minimum Time					1
form is used for	Defects Injected	Plan	Actual	To Date	To Date %	4
recording the	Design Review					4
	Code					1
planning data and	Code Review					4
summarizing the	Test					1
results	Total Defects Removed	Plan	Actual	To Data	To Date %	4
	Design	Fidit	Actual	To Date	TO Date /6	4
• Tables 19.1 and 19.2	Design Review					1
in [Humphrey 1997]	Code Code Review					4
	Compile					1
give instructions and	Test					4
an example for	Summary	Plan	Actual	To Date		4
a completing the form	LOC/Hour					]
completing the form.	Detects/KLOC Pre-Compile Yield					4
	The complet held					4









Ouality Me as ure         Description           Total de fects/KLOC         the number of de fects found in de velopment, per 1000 lines of code           Quality         Test de fects/KLOC         the number of de fects found in test, per 1000 lines of code           Process         Yield         the percent of de fects found be fore compile           Appraisal COQ         the percent of total de velopment time spent in (Cost of Quality)           Guality         Failure COQ         the percent of total de velopment time spent in compile and test           Total COO         Appraisal COQ + Failure COO         Appraisal COQ + Failure COO           A/F R         Appraisal COQ         Failure COQ           Proce view rate         the number of lines of code review of per hour in a review (code review or de sign review)           Defect removal rate         the rate at which defects are removed in a defect	Р	SP Qua	lity Measures
Product         Total defects/KLOC         the number of defects found in deve lopment, per 1000 lines of code           Quality         Test defects/KLOC         the number of defects found in deve lopment, per 1000 lines of code           Yield         Test defects/KLOC         the number of defects found in deve lopment, per 1000 lines of code           Yield         the percent of defects found be fore compile           Appraisal COQ         the percent of total deve loment time spent in (Cost of Quality) design revie wand code review           Quality         Failure COQ         the percent of total deve loment time spent in compile and test           Total COO         Appraisal COQ + Failure COQ         A/F R           Appraisal COQ         Failure COQ         Review rate           - LOC/hour         the number of lines of code review of design review)         Defect removal rate           defeate (hour         the rate at which defects are removed in a defect         the rate of defects are removed in a defect	0.0.9	lity Measure	Description
Quality         Test de fects/KLOC         the number of de fects found in test, per 1000 lines of code           Yield         the percent of de fects found be fore compile           Appraisal COQ         the percent of talde veloment time spent in (Cost of Quality)           Process         Quality           Failure COQ         the percent of total de veloment time spent in compile and test           Total COO         Appraisal COQ + Failure COO           A/F R         Appraisal COQ Failure COQ           Revie w rate         the number of lines of code review)           Defect removal rate         the number of lines of code review of in a defect           defect/hour         review (code review ordes ign review)	Product	Total de fe cts/KLOC	the number of defects found in development, per 1000 lines of code
Yield         the percent of defects found before compile           Appraisal COQ         the percent of total de velowent time spent in (Cost of Quality)           Quality         Failure COQ           Failure COQ         the percent of total de velowent time spent in compile and test           Total COQ         Appraisal COQ + Failure COQ           A/F R         Appraisal COQ Failure COQ           Revie w rate         the number of lines of code review)           Defect removal rate         the number of lines of code review)           Defect removal rate         the rate at which defects are removed in a defect	Quality	Te st de fe cts/KLOC	the number of defects found in test, per 1000 lines of code
Appraisal COQ         the percent of total develoment time spent in (Cost of Quality)           Process         Guality         Failure COQ         the percent of total develoment time spent in compile and test           Total COQ         Appraisal COQ + Failure COQ         Appraisal COQ + Failure COQ           AF R         Appraisal COQ + Failure COQ         Failure COQ           Review rate         the number of lines of code review of per hour in a - LOC/hour         the rate at which defects are removed in a defect defects/facts/		Yie ld	the percent of defects found before compile
Quality         Failure COQ         the percent of total development time spent in compile and test           Total COO         Appraisal COO + Failure COO           A/F R         Appraisal COQ.           Failure COQ         Review rate           - LOC/hour         review (code review ordesign review)           Defect removal rate         the rate at which defects are removed in a defect           defect/hour         review (code review ordesign review)	Process	Appraisal COQ (Cost of Quality)	the percent of total develoment time spent in design review and code review
Total COO     Appraisal COO + Failure COO       A/F R     Appraisal COQ       Failure COO     Failure COO       Re view rate     the number of lines of code re viewed per hour in a       - LOC/hour     re view (code re view orde sign re view)       Defect removal rate     the rate at which defects are removed in a defect       defect/hour     removal holds a (dearing review)	Quality	Failure COQ	the percent of total develoment time spent in compile and test
A/F R     AppraisalCOQ Failure COO       Re view rate     the number of lines of code re view ed per hour in a - LOC/hour       Defect removal rate     the rate at which defects are removed in a defect       defect (hour     removal hous ed (decine ratio)		TotalCOO	Appraisal COO + Failure COO
Review rate         the number of lines of code review ed per hour in a           - LOC/hour         review (code review ordesign review)           Defect removal rate         the rate at which defects are removed in a defect           defect/hour         removal base (decime ratio)		A/F R	AppraisalCOQ Failure COO
Defect removal rate the rate at which defects are removed in a defect defect (hour movel has a (design review code review)		Review rate - LOC/hour	the number of lines of code reviewed per hour in a review (code review or design review)
compile, test)		De fect re moval rate - de fects/hour	the rate at which defects are removed in a defect removal phase (design review, code review, compile, test)

















References
<ul> <li>[Davis 2003] Davis, N. and Mullaney, J., <i>The Team Software Process (TSP) in Practice: A Summary of Recent Results</i>, CMU/SEI-2003-TR-014, Software Engineering Institute, Carnegie Mellon University, September 2003.</li> <li>[Ferguson 1997]Ferguson, P., Humphrey, W., Khajenoori, S., Macke, S., and Matvya, A. "Introducing the Personal Software Process: Three Industry Case Studies," <i>Computer</i>, pp. 24-31, May 1997.</li> <li>[Hayes 97] Hayes, W. and Over, J.W., <i>The Personal Software Process: An Empirical Study of the Impact of PSP on Individual Engineers</i>, CMU/SEI-97-TR-001, Software Engineering Institute, Carnegie Mellon University, December 1997.</li> <li>[Humphrey 1995] Humphrey, Watts S., <i>A Discipline for Software Engineering</i>, Addison Wesley, 1995</li> <li>[Humphrey 1997] Humphrey, Watts S., <i>Introduction to the Personal Software Process</i>, Addison Wesley, 1997.</li> <li>[Paulk 1993] Paulk, Mark C., et. al., <i>Capability Maturity Model for Software</i>, Version 1.1, CMU/SEI-93-TR-024, Software Engineering Institute, Carnegie Mellon University, 1993.</li> <li>[SEMA 2003] Software Engineering Measurement and Analysis, <i>Process Maturity Profile: Software CMM, CBA IPI and SPA Appraisal Results</i>, 2003 Mid-Year Update, Software Engineering Institute, Carnegie Mellon University September 2003, http://www.sei.cmu.edu/sema/pdf/SW-CMM/2003sepSwCMM.pdf.</li> </ul>
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